



# DECLARATION OF CONFORMITY

according to ISO/IEC Guide 22 and EN 45014

**Manufacturer's Name and Address:**

Intel Europe, Inc  
1515 Route 10  
Parsippany, NJ 07054  
USA

**Representative in European Union:**

Intel Corporation (UK) Ltd  
Pipers Way  
Swindon, Wiltshire SN3 1RJ  
United Kingdom

Declare that the products:

**Description:**                    **High-density Digital Interface boards**

**References:**                    **Intel® NetStructure® DM/N1200-4E1-cPCI**  
**Intel® NetStructure® DM/T1200-4E1-cPCI**

**Equipment type :**                **DM3 cPCI platform version 1.8**

**Combined with:**                **Rear I/O module (75 Ohm) version 1.9**

Have been tested against and found in conformity with following Standards:

**SAFETY**                            EN 60950-1: 2001

**EMC**                                EN 55022:1994 + Amendment 1:1995 - Emissions (class B)  
EN 55024:1998 – Immunity  
EN 61000-4-2:1995 - Electrostatic Discharge  
EN 61000-4-3:1996 - Radiated EM field  
EN 61000-4-4:1995 - Fast Transient/Burst  
EN 61000-4-6:1996 - Conducted RF Disturbances

**Telecommunications**        TBR 4 A1 (December 1997) - Integrated Services Digital Network: attachment requirements for terminal equipment (TE) to be connected to the ISDN using a Primary Rate Access (Layer 1 measured using special IPATS interface for 75 Ohm).

Therefore, we declare that the above-mentioned products comply with the essential requirements of:

- the Low Voltage Directive 73/23/EEC
- the EMC Directive 89/336/EEC
- the Radio & Telecommunication Terminal Equipment (R&TTE) Directive 99/05/EC

when installed and used in accordance with the enclosed manual(s).

March 29, 2006

Jean-Luc Detrez, Jr.  
Approvals, Standards, and Architectures  
Intel Corporation